

EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S11	2	((board or substrate) with (ceramic) with (wiring or pattern or trace) with (via or hole or opening or bore or aperture) with (resin or epoxy) with (leg or pillar or projection or protrusion) with (terminal or electrode or contact or pad or land)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:04
S12	1	((board or substrate) same (ceramic) same (wiring or pattern or trace) same (via or hole or opening or bore or aperture) same (resin or epoxy) same (leg or pillar or projection or protrusion) same (terminal or electrode or contact or pad or land)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:05

S14	7	((board or substrate) same (ceramic) same (wiring or pattern or trace) same (via or hole or opening or bore or aperture) same (resin or epoxy) same (leg or pillar or projection or protrusion) same (terminal or electrode or contact or pad or land)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:06
S15	5	S14 not S11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:06
S16	27	((board or substrate) and (ceramic) and (wiring or pattern or trace) and (via or hole or opening or bore or aperture) and (resin or epoxy) and (leg or pillar or projection or protrusion) and (terminal or electrode or contact or pad or land)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:07
S17	30	((board or substrate) and (ceramic) and (wiring or pattern or trace) and (via or hole or opening or bore or aperture) and (resin or epoxy) and (leg or pillar or projection or protrusion) and (terminal or electrode or	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:07

		contact or pad or land)).clm.				
S18	20	S16 not (S14 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:08
S19	13	((board or substrate) with (ceramic) with (wiring or pattern or trace) with (via or hole or opening or bore or aperture) with (resin or epoxy) with (terminal or electrode or contact or pad or land)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:10
S20	13	S19 not (S16 or S14 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:10
S21	50	((board or substrate) with (ceramic) with (wiring or pattern or trace) with (via or hole or opening or bore or aperture) with (resin or epoxy) with (terminal or electrode or contact or pad or land)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:12
S22	45	S21 not (S19 or S16 or S14 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:12

S23	22	((board or substrate) same (ceramic) same (wiring or pattern or trace) same (via or hole or opening or bore or aperture) same (resin or epoxy) same (terminal or electrode or contact or pad or land)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:18
S24	226	((board or substrate) same (ceramic) same (wiring or pattern or trace) same (via or hole or opening or bore or aperture) same (resin or epoxy) same (terminal or electrode or contact or pad or land)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:18
S25	6	S23 not (S21 or S19 or S16 or S14 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:18
S27	162	S24 not (S23 or S21 or S19 or S16 or S14 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:19
S28	633	((board or substrate) and (ceramic) and (wiring or pattern or trace) and (via or hole or opening or bore or aperture) and (resin or epoxy) and (terminal or electrode or contact or pad or land)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:25

S29	509	((board or substrate) and (ceramic) and (wiring or pattern or trace) and (via or hole or opening or bore or aperture) and (resin or epoxy) and (terminal or electrode or contact or pad or land)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:25
S30	603	S28 not (S24 or S23 or S21 or S19 or S16 or S14 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:26
S31	14315	((board or substrate) and (ceramic) and (wiring or pattern or trace) and (via or hole or opening or bore or aperture) and (resin or epoxy) and (leg or pillar or projection or protrusion) and (terminal or electrode or contact or pad or land))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:38
S32	1322	S31 and ((resin or epoxy) with (leg or pillar or projection or protrusion))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:38
S33	1279	S32 not (S28 or S24 or S23 or S21 or S19 or S16 or S14 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/08/01 21:39

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